# RGS50TSX2HR

## 1200V 25A Field Stop Trench IGBT

Datasheet

V <sub>CES</sub>	1200V
I <sub>C (100°C)</sub>	50A
V <sub>CE(sat) (Typ.)</sub>	1.7V
$P_D$	395W

# Outline TO-247N (1)(2)(3)

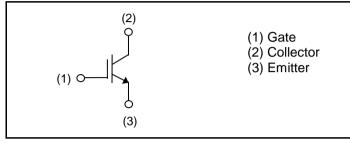
## Features

- 1) Low Collector Emitter Saturation Voltage
- 2) Short Circuit Withstand Time 10µs
- 3) Qualified to AEC-Q101
- 4) Pb free Lead Plating; RoHS Compliant

## Application

Heater for Automotive

## ●Inner Circuit



## Packaging Specifications

- r doing apromount						
	Packaging	Tube				
	Reel Size (mm)	-				
Tuno	Tape Width (mm)	-				
Туре	Basic Ordering Unit (pcs)	450				
	Packing Code	C11				
	Marking	RGS50TSX2				

## ● **Absolute Maximum Ratings** (at T<sub>C</sub> = 25°C unless otherwise specified)

			ı	
Parameter		Symbol	Value	Unit
Collector - Emitter Voltage		V <sub>CES</sub>	1200	V
Gate - Emitter Voltage		V <sub>GES</sub>	±30	V
Collector Current	$T_C = 25^{\circ}C$	I <sub>C</sub>	50	А
Collector Current	$T_C = 100$ °C	$T_C = 100$ °C $I_C$		Α
Pulsed Collector Current	I <sub>CP</sub> *1	75	А	
Dower Dissipation	$T_C = 25^{\circ}C$	P <sub>D</sub>	395	W
Power Dissipation	$T_C = 100$ °C	P <sub>D</sub>	197	W
Operating Junction Temperature	T <sub>j</sub>	-40 to +175	°C	
Storage Temperature		T <sub>stg</sub>	-55 to +175	°C

<sup>\*1</sup> Pulse width limited by T<sub>imax.</sub>

## ●Thermal Resistance

Parameter	Symbol	Values			Unit
raiailletei	Symbol	Min.	Тур.	Max.	
Thermal Resistance IGBT Junction - Case	$R_{\theta(j-c)}$	-	-	0.38	°C/W

## ●IGBT Electrical Characteristics (at T<sub>i</sub> = 25°C unless otherwise specified)

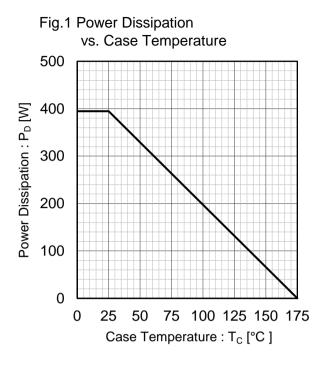
Parameter	Symbol	Conditions	Values			Unit
- raiametei	Symbol	Conditions	Min.	Тур.	Max.	Offic
Collector - Emitter Breakdown Voltage	BV <sub>CES</sub>	$I_{C} = 10 \mu A, V_{GE} = 0 V$	1200	-	-	V
		$V_{CE} = 1200V, V_{GE} = 0V,$				
Collector Cut - off Current	I <sub>CES</sub>	$T_j = 25^{\circ}C$ $Tj = 175^{\circ}C^{*2}$	-	-	10	μΑ
		$Tj = 175^{\circ}C^{^{*2}}$	1	ı	5	mA
Gate - Emitter Leakage Current	I <sub>GES</sub>	$V_{GE} = \pm 30V, V_{CE} = 0V$	1	ı	±500	nA
Gate - Emitter Threshold Voltage	$V_{\text{GE(th)}}$	$V_{CE} = 5V, I_{C} = 3.8 \text{mA}$	5.0	6.0	7.0	V
		$I_C = 25A, V_{GE} = 15V,$				
Collector - Emitter Saturation Voltage	V <sub>CE(sat)</sub>	T <sub>j</sub> = 25°C	-	1.70	2.10	V
		T <sub>j</sub> = 175°C	-	2.20	-	V

# ●IGBT Electrical Characteristics (at T<sub>j</sub> = 25°C unless otherwise specified)

Davamatas	Symbol	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input Capacitance	C <sub>ies</sub>	$V_{CE} = 30V$ ,	-	2095	-	
Output Capacitance	C <sub>oes</sub>	$V_{GE} = 0V$ ,	-	166	-	pF
Reverse transfer Capacitance	$C_{res}$	f = 1MHz	-	12	-	
Total Gate Charge	$Q_g$	V <sub>CE</sub> = 500V,	-	67	-	
Gate - Emitter Charge	$Q_{ge}$	I <sub>C</sub> = 25A,	-	19	-	nC
Gate - Collector Charge	$Q_{gc}$	$V_{GE} = 15V$	-	25	-	
Turn - on Delay Time	t <sub>d(on)</sub>		-	37	-	
Rise Time	t <sub>r</sub>	$I_C = 25A, V_{CC} = 600V,$ $V_{GE} = 15V, R_G = 10\Omega,$	-	16	-	no
Turn - off Delay Time	t <sub>d(off)</sub>	$T_i = 25^{\circ}C$	-	140	-	ns
Fall Time	t <sub>f</sub>	Inductive Load	-	205	-	
Turn - on Switching Loss	E <sub>on</sub>	*E <sub>on</sub> include diode reverse recovery	-	1.40	-	m l
Turn - off Switching Loss	E <sub>off</sub>	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	-	1.65	-	- mJ
Turn - on Delay Time	t <sub>d(on)</sub>		-	36	-	
Rise Time	t <sub>r</sub>	$I_C = 25A, V_{CC} = 600V,$ $V_{GE} = 15V, R_G = 10\Omega,$	-	17	-	
Turn - off Delay Time	t <sub>d(off)</sub>	$T_i = 175^{\circ}C$	-	170	-	ns
Fall Time	t <sub>f</sub>	Inductive Load	-	280	-	
Turn - on Switching Loss	E <sub>on</sub>	*E <sub>on</sub> include diode reverse recovery	-	1.50	-	m l
Turn - off Switching Loss	E <sub>off</sub>		-	2.20	-	mJ
Reverse Bias Safe Operating Area	RBSOA	$I_C = 75A$ , $V_{CC} = 1050V$ , $V_P = 1200V$ , $V_{GE} = 15V$ , $R_G = 50\Omega$ , $T_j = 175^{\circ}C$	FU	LL SQUA	RE	-
Short Circuit Withstand Time	t <sub>sc</sub>	$V_{CC} \le 600V$ , $V_{GE} = 15V$ , $T_j = 25^{\circ}C$	10	-	-	μs
Short Circuit Withstand Time	t <sub>sc</sub> *2	$V_{CC} \le 600V$ , $V_{GE} = 15V$ , $T_j = 150$ °C	8	-	-	μs

<sup>\*2</sup> Design assurance without measurement

## • Electrical Characteristic Curves



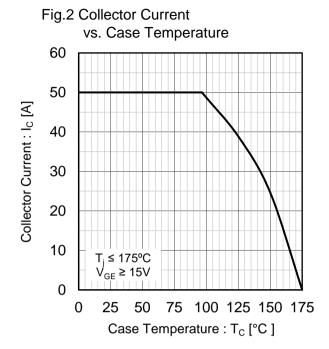


Fig.3 Forward Bias Safe Operating Area 1000 10µs 100 Collector Current : I<sub>C</sub> [A] 100µs 10 1 0.1  $T_{\rm C} = 25^{\circ}{\rm C}$ Single Pulse 0.01 10 100 1000 10000 Collector To Emitter Voltage: V<sub>CE</sub> [V]

Fig.4 Reverse Bias Safe Operating Area 100  $\overline{[V]}$  75  $\overline{[V]}$  75  $\overline{[V]}$  25  $\overline{[V]}$  25  $\overline{[V]}$  400 800 1200 1600  $\overline{[V]}$  Collector To Emitter Voltage :  $\overline{[V]}$ 

## ● Electrical Characteristic Curves

Fig.5 Typical Output Characteristics

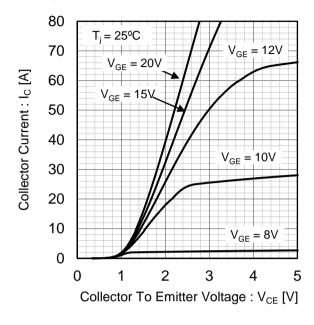


Fig.6 Typical Output Characteristics

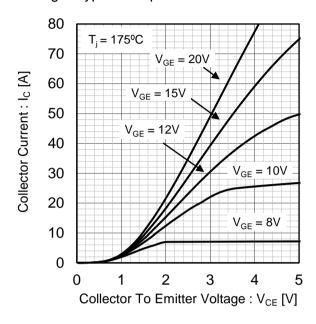


Fig.7 Typical Transfer Characteristics

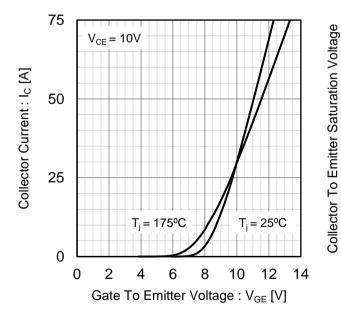
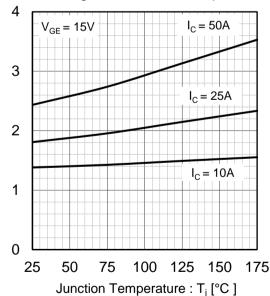


Fig.8 Typical Collector To Emitter Saturation
Voltage vs. Junction Temperature

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 $: V_{CE(sat)}[V]$ 

## ● Electrical Characteristic Curves

Fig.9 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage

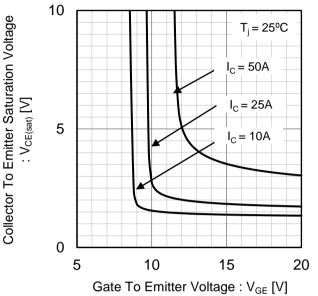


Fig.10 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage

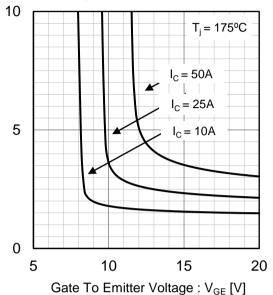


Fig.11 Typical Switching Time vs. Collector Current

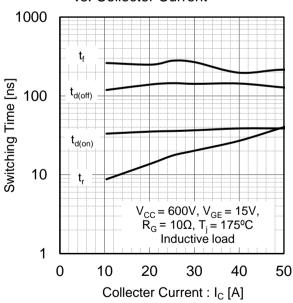
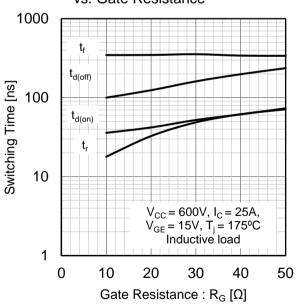


Fig.12 Typical Switching Time vs. Gate Resistance



Collector To Emitter Saturation Voltage

 $: V_{CE(sat)}[V]$ 

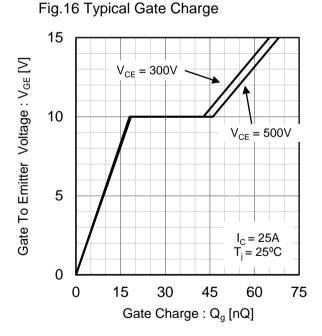
## **•**Electrical Characteristic Curves

Fig.13 Typical Switching Energy Losses vs. Collector Current 100 Switching Energy Losses [mJ] 10  $\mathsf{E}_{\mathsf{off}}$ 1  $V_{CC}$  = 600V,  $V_{GE}$  = 15V,  $R_{G}$  = 10 $\Omega$ ,  $T_{J}$  = 175°C Inductive load  $\mathsf{E}_{\mathsf{on}}$ 0.1 0 10 20 30 40 50 Collector Current : I<sub>C</sub> [A]

vs. Gate Resistance 100 Switching Energy Losses [mJ] 10  $\mathsf{E}_{\mathsf{off}}$ 1 E<sub>on</sub>  $V_{CC}$  = 600V,  $I_{C}$  = 25A,  $V_{GE}$  = 15V,  $T_{j}$  = 175°C Inductive load 0.1 0 10 20 30 40 50 Gate Resistance :  $R_G[\Omega]$ 

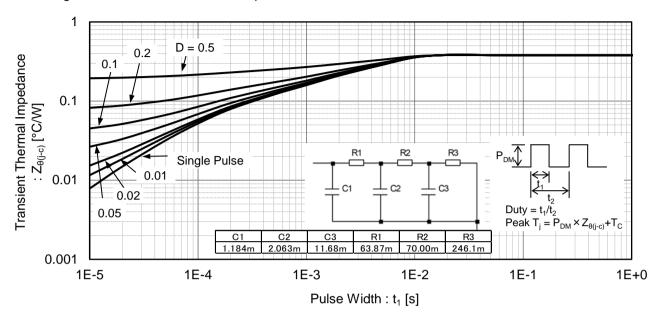
Fig.14 Typical Switching Energy Losses

Fig.15 Typical Capacitance vs. Collector To Emitter Voltage 10000 Cies 1000 Capacitance [pF] C<sub>oes</sub> 100 10 f = 1MHz $C_{res}$  $V_{GE} = 0V$  $T_i = 25^{\circ}C$ 1 0.01 0.1 10 100 Collector To Emitter Voltage: V<sub>CE</sub> [V]



## **•**Electrical Characteristic Curves

Fig.17 IGBT Transient Thermal Impedance



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## ●Inductive Load Switching Circuit and Waveform

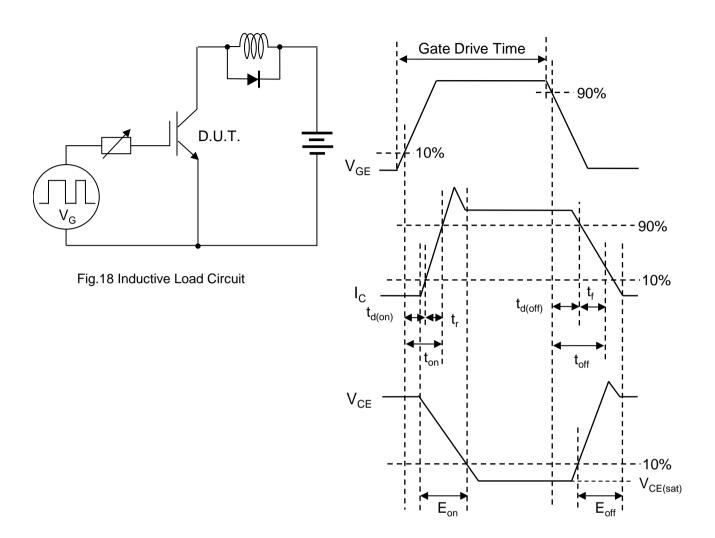


Fig.19 Inductive Load Waveform

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ſ	JÁPAN	USA	EU	CHINA
Ī	CLASSⅢ	CL ACCIII	CLASS II b	СГУССШ
ſ	CLASSIV	CLASSⅢ	CLASSⅢ	CLASSⅢ

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  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

## Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

## **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
  may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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# RGS50TSX2HR - Web Page

Part Number	RGS50TSX2HR
Package	TO-247N
Unit Quantity	450
Minimum Package Quantity	30
Packing Type	Tube
Constitution Materials List	inquiry
RoHS	Yes